

SY89809L

3.3V 1:9 High-Performance, Low-Voltage Bus Clock Driver

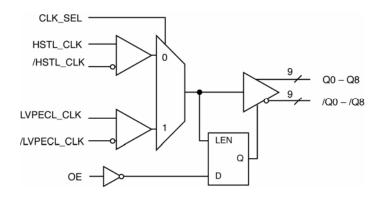
General Description

The SY89809L is a High-Performance Bus Clock Driver with 9 differential HSTL (High-Speed Transceiver Logic) output pairs. The part is designed for use in low-voltage (3.3V/1.8V) applications, which require a large number of outputs to drive precisely aligned, ultra-low skew signals to their destination. The input is multiplexed from either HSTL or LVPECL (Low-Voltage Positive-Emitter-Coupled Logic) by the CLK_SEL pin. The Output Enable (OE) is synchronous so that the outputs will only be enabled/disabled when they are already in the LOW state. This avoids any chance of generating a runt clock pulse when the device is enabled/disabled as can happen with an asynchronous control.

The SY89809L features low pin-to-pin skew (50ps max.) and low part-to-part skew (200ps max.)—performance previously unachievable in a standard product having such a high number of outputs. The SY89809L is available in a single space saving package, enabling a lower overall cost solution.

Datasheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Logic Symbol



Precision Edge[®]

Features

- 3.3V core supply, 1.8V output supply for reduced power
- LVPECL and HSTL inputs
- 9 differential HSTL (low-voltage swing) output pairs
- HSTL outputs drive 50Ω -to-ground with no offset voltage
- 500MHz maximum clock frequency
- Low part-to-part skew (200ps max.)
- Low pin-to-pin skew (50ps max.)
- · Available in 32-pin TQFP

Applications

- High-performance PCs
- Workstations
- · Parallel processor-based systems
- · Other high-performance computing
- Communications

Level	Direction	Signal
HSTL	Input	HSTL_CLK, /HSTL_CLK
HSTL	Output	Q0 – Q8, /Q0 – /Q8
LVPECL	Input	LVPECL_CLK, /LVPECL_CLK
LVCMOS/LVTTL	Input	CLK_SEL, OE

Table 1. Signal Groups

OE ⁽¹⁾	CLK_SEL	Q0 – Q8	/Q0 – /Q8
0	0	LOW	HIGH
0	1	LOW	HIGH
1	0	HSTL_CLK	/HSTL_CLK
1	1	LVPECL CLK	/LVPECL CLK

Table 2. Truth Table

Note:

 The OE (output enable) signal is synchronized with the low level of the HSTL_CLK and LVPECL_CLK signal.

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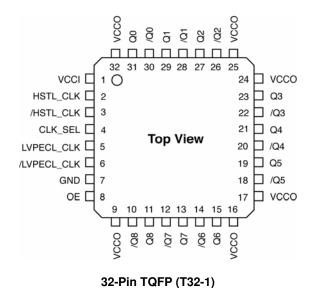
Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY89809LTC	T32-1	Commercial	SY89809LTC	Sn-Pb
SY89809LTCTR ⁽²⁾	T32-1	Commercial	SY89809LTC	Sn-Pb
SY89809LTH ⁽³⁾	T32-1	Commercial	SY89809LTH with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY89809LTHTR ^(2, 3)	T32-1	Commercial	SY89809LTH with Pb-Free bar-line indicator	NiPdAu Pb-Free

Notes:

- 1. Contact factory for die availability. Dice are guaranteed at T_A = 25°C, DC Electricals only.
- 2. Tape and Reel.
- 3. Pb-Free package is recommended for new designs.

Pin Configuration



Pin Description

Pin Number	Pin Name	Туре	Pin Function
2, 3	HSTL_CLK, /HSTL_CLK	HSTL Input	Differential input: This HSTL input can be selected by CLK_SEL. If it is not used, it can be left floating. This produces a LOW at the output. If driven by an HSTL driver, an external 50Ω to ground termination is required at the input.
5, 6	LVPECL_CLK, /LVPECL_CLK	LVPECL Input	Differential input: This LVPECL input can be selected by CLK_SEL. If it is not used, it can be left floating. This produces a LOW at the output (internal $75k\Omega$ pull-downs).
4	CLK_SEL	LVTTL Input	Selected HSTL_CLK input when LOW and LVPECL_CLK output when HIGH. 11k Ω pull-up.
8	OE	LVTTL Input	Single-ended input: This LVTTL input disables and enables the Q0-Q8 output pairs. It is internally synchronized to prevent glitching of the Q0-Q8 output pairs. It is internally connected to a 11k Ω pull-up resistor and will default to a logic HIGH state if left open.
31, 29, 27, 23, 21, 19, 15, 13, 11	Q0 – Q8	HSTL Output	Differential clock outputs from HSTL_CLK when CLK_SEL = LOW and LVPECL outputs when CLK_SEL = HIGH. HSTL outputs must be terminated with 50Ω to GND. Q0-Q8 outputs are static LOW when OE = LOW. Unused output pairs may be left floating.
30, 28, 26, 22, 20, 18, 14, 12, 10	/Q0 – /Q8	HSTL Output	Differential clock outputs from HSTL_CLK when CLK_SEL = LOW and LVPECL outputs when CLK_SEL = HIGH. HSTL outputs must be terminated with 50Ω to GND. /Q0-/Q8 outputs are static HIGH when OE = LOW. Unused output pairs may be left floating.
1	VCCI	VCC Core Power	Core V_{CC} connected to 3.3V supply. Bypass with 0.1 μ F in parallel with 0.01 μ F low ESR capacitors as close to V_{CCI} pin as possible.
9, 16, 17, 24, 25, 32	VCCO	VCC Output Power	Output Buffer VCC connected to 1.8V supply. Bypass with $0.1\mu F$ in parallel with $0.01\mu F$ low ESR capacitors as close to V_{CCO} pins as possible. All V_{CCO} pins should be connected together on the PCB.
7	GND	Ground	Ground.

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V _{IN})	–0.5V to $V_{\rm CCI}$
V _{CC} Pin Potential to Ground Pin	
(V _{CCI} , V _{CCO})	0.5V to +4.0V
DC Output Current, Output HIGH (IOUT)	–50mA
Lead Temperature (soldering, 20sec.)	260°C
Storage Temperature (T _s)	–65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage	
(V _{CCI})	+3.0V to +3.6V
(V _{CCO})	
Ambient Temperature (T _A)	0°C to +85°C
Package Thermal Resistance	
$TQFP\left(\theta_{JA}\right)$	
–Still-Áir	50°C/W
_500lfpm	42°C/W
TQFP (θ ₁₀)	

DC Electrical Characteristics

 $T_A = 0$ °C to +85°C, unless noted.

Power Supply

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{CCI}	V _{CC} Core		3.0	3.3	3.6	V
V _{CCO}	V _{CC} Output		1.6	1.8	2.0	V
I _{CCI}	I _{CC} Core			115	140	mA

HSTL

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{OH}	Output HIGH Voltage ⁽³⁾		1.0		1.2	V
V _{OL}	Output LOW Voltage ⁽³⁾		0.2		0.4	V
V _{IH}	Input HIGH Voltage		V _X +0.1		1.6	V
V _{IL}	Input LOW Voltage		-0.3		V _X –0.1	V
V _X	Input Crossover Voltage		0.68		0.9	V
I _{IH}	Input HIGH Current		+20		-350	μΑ
I _{IL}	Input LOW Current				-500	μA

LVPECL

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{IH}	Input HIGH Voltage		V _{CCI} -1.165		V _{CCI} -0.880	V
V _{IL}	Input LOW Voltage		V _{CCI} -1.810		V _{CCI} -1.475	V
I _{IH}	Input HIGH Current				+150	μΑ
I _{IL}	Input LOW Current		0.5			μΑ

LVCMOS/LVTTL

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{IH}	Input HIGH Voltage		2.0			V
V _{IL}	Input LOW Voltage				0.8	V
I _{IH}	Input HIGH Current		+20		-250	μA
I _{IL}	Input LOW Current				-600	μA

Notes:

- 1. Exceeding the absolute maximum rating may damage the device.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. Outputs loaded with 50Ω to ground.

AC Electrical Characteristics⁽⁴⁾

 $T_A = 0$ °C to +85°C, unless noted.

Symbol	Parameter	Condition	Min	Тур	Max	Units
t _{PD}	Propagation Delay ⁽⁵⁾		825	1050	1275	ps
f _{MAX}	Maximum Operating Frequency ⁽⁶⁾		500			MHz
t _{SKEW}	Within-Device Skew ⁽⁷⁾				50	ps
t _{SKPP}	Part-to-Part Skew ⁽⁸⁾				200	ps
t _{JITTER}	Phase Noise(RMS)	12kHz-20MHz @ 500MHz		0.241	1	ps
		See Figure 3				
V_{PP}	Minimum Input Swing ⁽⁹⁾ LVPECL_CLK		600			mV
V _{CMR}	Common Mode Range ⁽¹⁰⁾ LVPECL_CLK		-1.5		-0.4	V
ts	OE Set-Up Time ⁽¹¹⁾		1.0			ns
t _H	OE Hold Time		0.5			ns
t _r , t _f	Output Rise/Fall Time (20% to 80%)		300		650	ps

Notes:

- 4. Outputs loaded with 50Ω to ground. Airflow ≥ 300 lfpm.
- 5. Differential propagation delay is defined as the delay from the crossing point of the differential input signals to the crossing point of the differential output signals.
- 6. Output swing greater than 450mV.
- The within-device skew is defined as the worst-case difference between any two similar delay paths within a single device operating at the same voltage and temperature.
- 8. The part-to-part skew is defined as the absolute worst-case difference between any two delay paths on any two devices operating at the same voltage and temperature.
- 9. The V_{PP}(min) is defined as the minimum input differential voltage which will cause no increase in the propagation delay.
- 10. V_{CMR} is defined as the range within which the VIH level may vary with the device still meeting the propagation delay specification. The numbers in the table are referenced to V_{CCI}. The VIL level must be such that the peak-to-peak voltage is less than 1.0V and greater than or equal to V_{PP}(min).
- 11. OE set-up time is defined with respect to the rising edge of the clock. OE HIGH-to-LOW transition ensures outputs remain disabled during the next clock cycle.

Output Waveforms

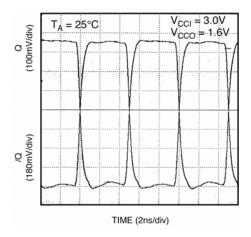


Figure 1. 100MHz Output Waveform

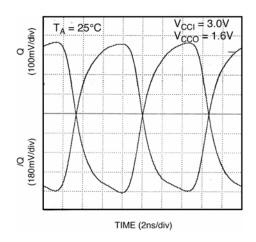


Figure 2. 300MHz Output Waveform

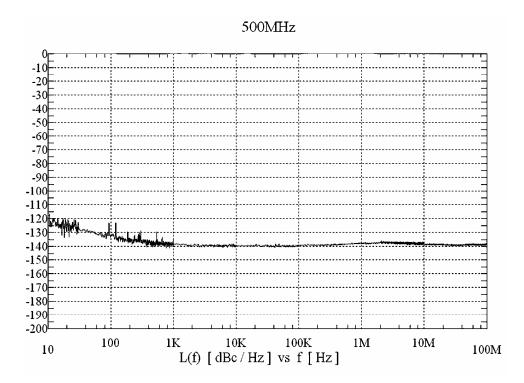
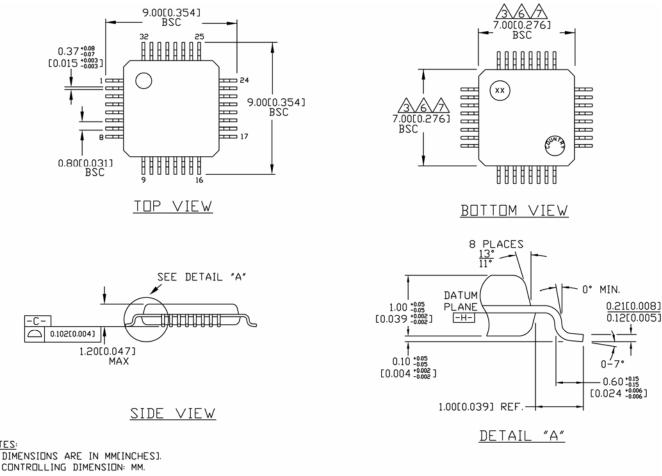


Figure 4. Phase Noise Plot

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Package Information



DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.254 [0.010].

LEAD DIMENSION DOES NOT INCLUDE DAMBAR

PROTRUSION.

MAXIMUM AND MINIMUM SPECIFICATIONS ARE INDICATED AS FOLLOWS: MAX/MIN.

THESE DIMENSIONS TO BE DETERMINED AT DATUM PLANE —H—

PACKAGE TOP DIMENSIONS ARE SMALLER THAN BOTTOM DIMENSIONS AND TOP OF PACKAGE WILL NOT OVERHANG BOTTOM OF PACKAGE.

32-Pin TQFP (T32-1)

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